

Group 43

Michelle Dubon, EE Victor Lopes, EE Joseph Brown, CpE Manuel Parilli, EE

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Motivation

- Apply knowledge of electrical design to the development of a navigation device.
- According to a 2015 study done by the CDC on the burden of vision loss, a total of 1.02 million people were blind, and approximately 3.2 million people in the U.S. had vision impairment (VI).
- There has been widespread latency on the development of navigation devices capable of guiding the blind through indoor and/or outdoor scenarios.
- Due to the nature of the wearable device, it can be used by non-visually impaired persons to help users navigate in the dark or in locations that have elevation changes.

Goals/Objectives

Our goals/objectives for this project were to create a wearable device that could:

- Detect objects in front of and to the sides of the user, as well as how far it is relative to the user;
- Detect objects coming in the direction of the user;
- Detect elevation changes in the terrain, which would reduce the possibility of falling by the user;
- All of these detections would trigger engagement of a state of alert when an object would cross the user's path.

Requirement Specifications

Friendly Eyes must be able to scan user's field of view up to 7 m away and produce a mechanical output.

Friendly Eyes must issue and prioritize alerts prompted by objects coming into 10 m from the user and doing so with speeds faster than 2m/s relative to the Earth.

FriendlyEyes must keep track of its distance from the background and alert the user of sudden changes in the level of the terrain ahead of an incident.

Friendly Eyes must produce all alerts within 1/8 seconds of sensing.

Hardware Block Diagram No PCB Design

Power **Block** Diagram No PCB Design

Sensors Block Diagram No PCB Design

Schematic Design

All the individuals pieces were assembled into one large schematic in Autodesk Eagle.

All voltage regulator circuits we used were predesigned in TI WEBENCH.

PCB Design

- 4 layer board
- Large GND plane on bottom layer
- Ordered from 4PCB
- Assembled with assistance from friend electrical engineer.

AC to DC Converters: Charging Station

- Wall wart designed to accept 120 AC and convert to 12V DC.
- MP2018 linear regulator designed to step-down 12V DC to 5V DC.
	- Selectable 3.3V or 5V fixed output voltage regulator, 5000mA maximum output current
	- $3V$ to $16V$ input voltage range
- MCP7381/2 linear charge

management controller designed to step-down 5V DC to 4.2V to charge the battery.

- Fixed output voltage regulation options: 4.2V, 4.35V, 4.4V, 4.5V, 500 mA maximum output current
- 3.75V to 6V input voltage range

DC to DC Converters: INS3330 & URM09

- ISL9111 boost converter designed to step-up 3.7V from the battery to the INS3330 radar sensor and URM09 ultrasonic sensor.
	- 5V output voltage, 800mA output current
	- 0.5V to 4.8V input voltage range

SW EN VOUT **FAULT** GND C $C4$ $+14$ $4.7UF$ GND

VBAT TO 5V BOOST

DC to DC Converters: MAX32625

These three voltage regulators were designed to step-down 3.7V to power the MAX32625 processor.

- NCP115ASN180T2G
	- 1.8V fixed output voltage, 300mA maximum output current
	- 1.7V to 5.5V input voltage range
- MIC5205-3.3YM5-TR
	- 3.3V output voltage, 150mA maximum output current
	- 2.5V to 16V input voltage range

● MIC5258-1.2YM5-TR

- 1.2V output voltage, 150mA maximum output current
- 2.6V to 6V input voltage range

DC to DC Converters: A1111 Radar Sensor

These two voltage regulators were designed to step-down 3.7V to power the A111 radar sensor.

- **● ST1S12G18R**
	- Selectable fixed output voltage of 1.2V and 1.8V, 700mA maximum output current
	- 2.5V to 5.5V input voltage range
- SIP32431DR3-T1GE3
	- High -enable logic load switch
		- Programmable voltage 1.8V
		- 1400mA maximum output current
	- 1.5V to 5.5V input voltage

Power: What we needed vs. What we had

With PCB design Without PCB design

Battery Selection and Testing

- Li vs Li-Po
- Testing Set-up
- Results

Custom PCB and A111 Sensor: What didn't make it

- Supply issues in obtaining components
	- Power system unable to complete integration
- Microcontroller issues in interfacing with Acconeer APIs
	- Flashing issues with the MAX32625PICO

A111 Sensor Issues

- Closed Source Libraries
- \bullet C++ functions in C
- Keil Conversion
- Flashing Issues
- Maxim Tool Chain

MAX 32625: MCU Overview

Arm Cortex M4 CPU - requirement for A111

UART, and SPI interfaces - USB debugging and A111 interfacing

Low Cost - Cheap development board

GPIO pins - Ultrasonic sensors, INS3330 radar module

Software **Block** Diagram

US100 Ultrasonic Sensors Integration

Prototyping and Testing

- A US100 sensor circuit was constructed on a breadboard in order to verify it could pick up close proximity objects and terrain elevation changes.
- This circuit was used in conjunction with the MAX32325 and a single vibrating motor to test functionality of the system before through-hole assembly.

L293D Motor Driver Integration

Prototyping and Testing

- A L293D motor driver circuit was constructed on a breadboard to control the motors.
- Once we verified that all three motors worked, this circuit was used in conjunction with the microcontroller and the sensors. We tested the functionality of the system before through-hole assembly.

INS3330 Radar Sensor Integration

Prototyping and Testing

- A INS330 sensor circuit was constructed on a breadboard in order to verify it could pick up object approaching the sensor and therefore the user.
- This circuit was used in conjunction with the MAX32325 and a single vibrating motor to test functionality of the system before through-hole assembly.

Budget

Total Budget: \$730

- \$380 spent on PCB
	- \$410 spent of 4 boards
	- \$110 spent on express shipping
- \$350 spent on parts
	- Primary 9V batteries, MCU, sensors, motors, surface mount chips
	- ICs, passives, connectors
- Other costs not factored into budget
	- Soldering iron, solder, pcb holder case, pcb holder bag, chest strap

Expected Budget

Challenges and Pitfalls

Hardware

- PCB issues
	- Lack of test points on PCB
	- No ability to isolate hardware blocks for testing on PCB
	- Chain supply issues caused certain chips that would have help our prototype were out of stock.

Integration (No PCB)

- Right voltage inputs
- Sensors/Motors not working
- Problem with cables

Testing

